## DATASHEET

# Description

The 9FGL04 devices are 3.3V members of IDT's 3.3V Full-Featured PCIe family. The devices have 4 output enables for clock management and support 2 different spread spectrum levels in addition to spread off. The 9FGL04 supports PCIe Gen1-4 Common Clocked architectures (CC) and PCIe Separate Reference no-Spread (SRIS) and Separate Reference Independent Spread (SRIS) clocking architectures. The 9FGL04P1 can be programmed with a user-defined power up default SMBus configuration.

# **Recommended Application**

PCIe Gen1-4 clock generation for Riser Cards, Storage, Networking, JBOD, Communications, Access Points

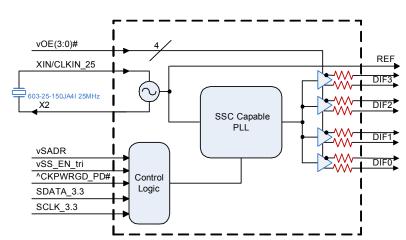
# **Output Features**

- 4 100 MHz Low-Power HCSL (LP-HCSL) DIF pairs
  - 9FGL0441 default ZOUT = 100Ω
  - 9FGL0451 default ZOUT = 85Ω
  - 9FGL04P1 factory programmable defaults
- 1 3.3V LVCMOS REF output w/Wake-On-LAN (WOL) support
- Easy AC-coupling to other logic families, see IDT application note <u>AN-891</u>

# **Key Specifications**

- PCIe Gen1-2-3-4 CC-compliant
- PCIe Gen2-3 SRIS-compliant
- DIF cycle-to-cycle jitter <50ps</li>
- DIF output-to-output skew <50ps</li>
- DIF 12k-20M phase jitter is <2ps rms when SSC is off
- REF phase jitter is <300fs rms (SSC off) and < 1.5ps RMS (SSC on)
- ±100ppm frequency accuracy on all clocks

# **Block Diagram**

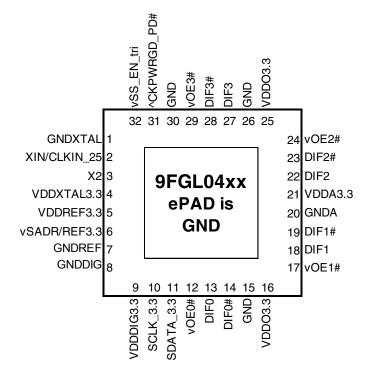


Note: Resistors default to internal on 41/51 devices. P1 devices have programmable default impedances on an output-by-output basis.

# Features/Benefits

- Direct connection to 100Ω (xx41) or 85Ω (xx51) transmission lines; saves 16 resistors compared to standard PCIe devices
- 142mW typical power consumption (@3.3V); eliminates thermal concerns
- SMBus-selectable features allows optimization to customer requirements:
  - control input polarity
  - control input pull up/downs
  - slew rate for each output
  - differential output amplitude
  - 33, 85 or  $100\Omega$  output impedance for each output
  - spread spectrum amount
- 41 and 51 devices contain default configuration; SMBus interface not required for device operation
- P1 device allows factory programming of customer-defined input/output frequencies and SMBus power up default; allows exact optimization to customer requirements.
- OE# pins; support DIF power management
- 8MHz 40MHz input frequency with 9FGL04P1 device (25MHz default); flexibility
- Pin/SMBus selectable 0%, -0.25% or -0.5% spread on DIF outputs %; minimize EMI and phase jitter for each application
- DIF outputs blocked until PLL is locked; clean system start-up
- Two selectable SMBus addresses; multiple devices can easily share an SMBus segment
- Space saving 32-pin 5x5mm VFQFPN; minimal board space

# **Pin Configuration**



## 32-pin VFQFPN, 5x5 mm, 0.5mm pitch

^ prefix indicates internal 120KOhm pull up resistor v prefix indicates internal 120KOhm pull down resistor

## **SMBus Address Selection Table**

|                                    | SADR | Address | + Read/Write Bit |
|------------------------------------|------|---------|------------------|
| State of SADR on first application | 0    | 1101000 | Х                |
| of CKPWRGD_PD#                     | 1    | 1101010 | Х                |

## **Power Management Table**

| CKPWRGD PD# | SMBus  | OEx# | DIFx/                 | DIFx/DIFx#            |                       |  |
|-------------|--------|------|-----------------------|-----------------------|-----------------------|--|
|             | OE bit | Pin  | True O/P              | Comp. O/P             | REF                   |  |
| 0           | Х      | Х    | Low <sup>1</sup>      | Low <sup>1</sup>      | Hi-Z <sup>2</sup>     |  |
| 1           | 1      | 0    | Running               | Running               | Running               |  |
| 1           | 1      | 1    | Disabled <sup>1</sup> | Disabled <sup>1</sup> | Running               |  |
| 1           | 0      | Х    | Disabled <sup>1</sup> | Disabled <sup>1</sup> | Disabled <sup>4</sup> |  |

1. The output state is set by B11[1:0] (Low/Low default)

2. REF is Hi-Z until the 1st assertion of CKPWRGD\_PD# high. After this, when CKPWRG\_PD# is low, REF is disabled unless Byte3[5]=1, in which case REF is running..

3. Input polarities defined at default values for 9FGLxx41/xx51.

4. See SMBus description for Byte 3, bit 4

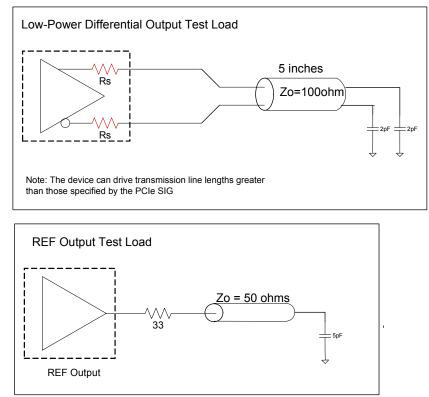
## **Power Connections**

| Pin Number |            | Description   |
|------------|------------|---------------|
| VDD        | GND        | Description   |
| 4          | 1          | XTAL Analog   |
| 5          | 7          | REF Output    |
| 9          | 8, 30      | Digital Power |
| 16, 25     | 15, 26, 33 | DIF outputs   |
| 21         | 20         | PLL Analog    |

# **Pin Descriptions**

| Pin# | Pin Name     | Туре           | Pin Description   |
|------|--------------|----------------|---|
| 1    | GNDXTAL      | GND            | GND for XTAL  |
| 2    | XIN/CLKIN_25 | IN             | Crystal input or Reference Clock input. Nominally 25MHz.  |
| 3    | X2           | OUT            | Crystal output.   |
| 4    | VDDXTAL3.3   | PWR            | Power supply for XTAL, nominal 3.3V   |
| 5    | VDDREF3.3    | PWR            | VDD for REF output. nominal 3.3V.   |
| 6    | vSADR/REF3.3 | LATCHED<br>I/O | Latch to select SMBus Address/3.3V LVCMOS copy of X1/REFIN pin  |
| 7    | GNDREF       | GND            | Ground pin for the REF outputs.   |
| 8    | GNDDIG       | GND            | Ground pin for digital circuitry  |
| 9    | VDDDIG3.3    | PWR            | 3.3V digital power (dirty power)  |
| 10   | SCLK_3.3     | IN             | Clock pin of SMBus circuitry, 3.3V tolerant.  |
| 11   | SDATA_3.3    | I/O            | Data pin for SMBus circuitry, 3.3V tolerant.  |
| 12   | vOE0#        | IN             | Active low input for enabling DIF pair 0. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs   |
| 13   | DIF0         | OUT            | Differential true clock output  |
| 14   | DIF0#        | OUT            | Differential Complementary clock output   |
| 15   | GND          | GND            | Ground pin.   |
| 16   | VDDO3.3      | PWR            | Power supply for outputs, nominal 3.3V.   |
| 17   | vOE1#        | IN             | Active low input for enabling DIF pair 1. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs   |
| 18   | DIF1         | OUT            | Differential true clock output  |
| 19   | DIF1#        | OUT            | Differential Complementary clock output   |
| 20   | GNDA         | GND            | Ground pin for the PLL core.  |
| 21   | VDDA3.3      | PWR            | 3.3V power for the PLL core.  |
| 22   | DIF2         | OUT            | Differential true clock output  |
| 23   | DIF2#        | OUT            | Differential Complementary clock output   |
| 24   | vOE2#        | IN             | Active low input for enabling DIF pair 2. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs   |
| 25   | VDDO3.3      | PWR            | Power supply for outputs, nominal 3.3V.   |
| 26   | GND          | GND            | Ground pin.   |
| 27   | DIF3         | OUT            | Differential true clock output  |
| 28   | DIF3#        | OUT            | Differential Complementary clock output   |
| 29   | vOE3#        | IN             | Active low input for enabling DIF pair 3. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs   |
| 30   | GND          | GND            | Ground pin.   |
| 31   | ^CKPWRGD_PD# | IN             | Input notifies device to sample latched inputs and start up on first high assertion.<br>Low enters Power Down Mode, subsequent high assertions exit Power Down<br>Mode. This pin has internal pull-up resistor. |
| 32   | vSS_EN_tri   | LATCHED IN     | Latched select input to select spread spectrum amount at initial power up : $1 = -0.5\%$ spread, M = -0.25%, 0 = Spread Off   |
| 33   | ePAD         | GND            | Connect to ground   |

# **Test Loads**



#### Terminations

| Device   | Ζο (Ω) | Rs (Ω)      |
|----------|--------|-------------|
| 9FGL0441 | 100    | None needed |
| 9FGL0451 | 100    | 7.5         |
| 9FGL04P1 | 100    | Prog.       |
| 9FGL0441 | 85     | N/A         |
| 9FGL0451 | 85     | None needed |
| 9FGL04P1 | 85     | Prog.       |

## **Alternate Terminations**

The 9FGL family can easily drive LVPECL, LVDS, and CML logic. See <u>"AN-891 Driving LVPECL, LVDS, and CML Logic with</u> <u>IDT's "Universal" Low-Power HCSL Outputs</u>" for details.

# **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 9FGL04. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER                 | SYMBOL          | CONDITIONS                | MIN  | TYP | МАХ                  | UNITS | NOTES |
|---------------------------|-----------------|---------------------------|------|-----|----------------------|-------|-------|
| Supply Voltage            | VDDx            |                           | -0.5 |     | 4.6                  | V     | 1,2   |
| Input Voltage             | V <sub>IN</sub> |                           | -0.5 |     | V <sub>DD</sub> +0.5 | V     | 1,3   |
| Input High Voltage, SMBus | VIHSMB          | SMBus clock and data pins |      |     | 3.9                  | V     | 1     |
| Storage Temperature       | Ts              |                           | -65  |     | 150                  | °C    | 1     |
| Junction Temperature      | Tj              |                           |      |     | 125                  | °C    | 1     |
| Input ESD protection      | ESD prot        | Human Body Model          | 2500 |     |                      | V     | 1     |

 $^1\mbox{Guaranteed}$  by design and characterization, not 100% tested in production.

<sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>3</sup> Not to exceed 4.6V.

## **Electrical Characteristics-SMBus Parameters**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                    | SYMBOL              | CONDITIONS                           | MIN | TYP | MAX  | UNITS | NOTES |
|------------------------------|---------------------|--------------------------------------|-----|-----|------|-------|-------|
| SMBus Input Low Voltage      | VILSMB              | $V_{DDSMB} = 3.3V$                   |     |     | 0.8  | V     |       |
| SMBus Input High Voltage     | VIHSMB              | $V_{DDSMB} = 3.3V$                   | 2.1 |     | 3.6  | V     |       |
| SMBus Output Low Voltage     | V <sub>OLSMB</sub>  | @ I <sub>PULLUP</sub>                |     |     | 0.4  | V     |       |
| SMBus Sink Current           | I <sub>PULLUP</sub> | @ V <sub>OL</sub>                    | 4   |     |      | mA    |       |
| Nominal Bus Voltage          | V <sub>DDSMB</sub>  |                                      | 2.7 |     | 3.6  | V     |       |
| SCLK/SDATA Rise Time         | t <sub>RSMB</sub>   | (Max VIL - 0.15) to (Min VIH + 0.15) |     |     | 1000 | ns    | 1     |
| SCLK/SDATA Fall Time         | t <sub>FSMB</sub>   | (Min VIH + 0.15) to (Max VIL - 0.15) |     |     | 300  | ns    | 1     |
| SMBus Operating<br>Frequency | f <sub>SMB</sub>    | SMBus operating frequency            |     |     | 500  | kHz   | 2     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2.</sup> The device must be powered up for the SMBus to function.

# Electrical Characteristics–Input/Supply/Common Parameters–Normal Operating Conditions

|                                  |                     | · · · · · · · · · · · · · · · · · · ·   |                | -               |                       |        |       |
|----------------------------------|---------------------|---|----------------|-----------------|-----------------------|--------|-------|
| PARAMETER                        | SYMBOL              | CONDITIONS  | MIN            | TYP             | МАХ                   | UNITS  | NOTES |
| Supply Voltage                   | VDDxxx              | Supply voltage for core, analog and single-ended LVCMOS outputs.  | 3.135          | 3.3             | 3.465                 | V      |       |
| Ambient Operating<br>Temperature | T <sub>AMB</sub>    | Industrial range  | -40            | 25              | 85                    | °C     |       |
| Input High Voltage               | V <sub>IH</sub>     | Single-ended inputs, except SMBus   | $0.75 V_{DDx}$ |                 | $V_{DDx} + 0.3$       | V      |       |
| Input Low Voltage                | VIL                 | Single-ended inputs, except SMBds   | -0.3           |                 | $0.25 V_{DDx}$        | V      |       |
| Input High Voltage               | V <sub>IHtri</sub>  |   | $0.75 V_{DDx}$ |                 | V <sub>DD</sub> + 0.3 | V      |       |
| Input Mid Voltage                | V <sub>IMtri</sub>  | Single-ended tri-level inputs ('_tri' suffix)   | $0.4 V_{DDx}$  | $0.5 \ V_{DDx}$ | 0.6 V <sub>DDx</sub>  | V      |       |
| Input Low Voltage                | V <sub>ILtri</sub>  |   | -0.3           |                 | 0.25 V <sub>DDx</sub> | V      |       |
|                                  | I <sub>IN</sub>     | Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$  | -5             |                 | 5                     | uA     |       |
| Input Current                    | I <sub>INP</sub>    | Single-ended inputs<br>$V_{IN} = 0$ V; Inputs with internal pull-up resistors<br>$V_{IN} =$ VDD; Inputs with internal pull-down resistors | -50            |                 | 50                    | uA     |       |
| Input Frequency                  | F <sub>in</sub>     | XTAL, or X1 input   | 8              | 25              | 40                    | MHz    | 4     |
| Pin Inductance                   | L <sub>pin</sub>    |   |                |                 | 7                     | nH     | 1     |
| Conseitones                      | C <sub>IN</sub>     | Logic Inputs, except DIF_IN   | 1.5            |                 | 5                     | pF     | 1     |
| Capacitance                      | C <sub>OUT</sub>    | Output pin capacitance  |                |                 | 6                     | pF     | 1     |
| Clk Stabilization                | T <sub>STAB</sub>   | From V <sub>DD</sub> Power-Up and after input clock<br>stabilization or de-assertion of PD# to 1st clock                                  |                | 0.34            | 1.8                   | ms     | 1,2   |
| SS Modulation Frequency          | f <sub>MOD</sub>    | Allowable Frequency<br>(Triangular Modulation)  | 30             | 31.6            | 33                    | kHz    | 1     |
| OE# Latency                      | t <sub>LATOE#</sub> | DIF start after OE# assertion<br>DIF stop after OE# deassertion   | 1              |                 | 3                     | clocks | 1,3   |
| Tdrive_PD#                       | t <sub>DRVPD</sub>  | DIF output enable after<br>PD# de-assertion   |                |                 | 300                   | us     | 1,3   |
| Tfall                            | t <sub>F</sub>      | Fall time of single-ended control inputs  |                |                 | 5                     | ns     | 1,2   |
| Trise                            | t <sub>R</sub>      | Rise time of single-ended control inputs  |                |                 | 5                     | ns     | 1,2   |

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Control input must be monotonic from 20% to 80% of input swing.

 $^3$  Time from deassertion until outputs are >200 mV

<sup>4</sup> The 9FGLxxP1 devices can be programmed for various input frequencies from 8 to 40MHz. The 9FGLxx41/51 devices use 25MHz.

# **Electrical Characteristics–DIF Low-Power HCSL Outputs**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| 7 WID; 11 3 6              |                         | allori conditione, coo reet Leade for Leading cond |       | r    | r      |       |         |
|----------------------------|-------------------------|--|-------|------|--------|-------|---------|
| PARAMETER                  | SYMBOL                  | CONDITIONS   | MIN   | TYP  | MAX    | UNITS | NOTES   |
| Slew rate                  | Trf                     | Scope averaging on, fast setting                   | 1.9   | 2.7  | 4      | V/ns  | 2,3     |
| Slew late                  | 111                     | Scope averaging, slow setting                      | 1     | 2.0  | 3      | V/ns  | 2,3     |
| Crossing Voltage (abs)     | Vcross_abs              | Scope averaging off                                | 250   | 405  | 550    | mV    | 1,4,5   |
| Crossing Voltage (var)     | ∆-Vcross                | Scope averaging off                                |       | 14   | 140    | mV    | 1,4,9   |
| Avg. Clock Period Accuracy | T <sub>PERIOD_AVG</sub> |  | -100  | 0    | +2600  | ppm   | 2,10,13 |
| Absolute Period            | T <sub>PERIOD_ABS</sub> | Includes jitter and Spread Spectrum Modulation     | 9.847 | 10   | 10.203 | ns    | 2,6     |
| Jitter, Cycle to cycle     | t <sub>jcyc-cyc</sub>   |  |       | 37   | 50     | ps    | 2,15    |
| Voltage High               | V <sub>HIGH</sub>       |  | 660   | 766  | 850    | mV    | 1       |
| Voltage Low                | V <sub>LOW</sub>        |  | -150  | 21   | 150    | ΠIV   | 1       |
| Absolute Max Voltage       | Vmax                    |  |       | 797  | 1150   | mV    | 1,7,15  |
| Absolute Min Voltage       | Vmin                    |  | -300  | -22  |        | IIIV  | 1,8,15  |
| Duty Cycle                 | t <sub>DC</sub>         |  | 45    | 49.4 | 55     | %     | 2       |
| Slew rate matching         | ∆Trf                    |  |       | 8    | 20     | %     | 1,14    |
| Skew, Output to Output     | t <sub>sk3</sub>        | Averaging on, $V_T = 50\%$                         |       | 21   | 50     | ps    | 2       |

<sup>1</sup> Measured from single-ended waveform.

<sup>2</sup> Measured from differential waveform.

<sup>3</sup> Measured from -150 mV to +150 mV on the differential waveform (derived from REFCLK+ minus REFCLK-). The signal must be monotonic through the measurement region for rise and fall time. The 300 mV measurement window is centered on the differential zero crossing.

<sup>4</sup> Measured at crossing point where the instantaneous voltage value of the rising edge of REFCLK+ equals the falling edge of REFCLK-.

<sup>5</sup> Refers to the total variation from the lowest crossing point to the highest, regardless of which edge is crossing. Refers to all crossing points for this measurement.

<sup>6</sup> Defines as the absolute minimum or maximum instantaneous period. This includes cycle to cycle jitter, relative PPM tolerance, and spread spectrum modulation.

<sup>7</sup> Defined as the maximum instantaneous voltage including overshoot.

<sup>8</sup> Defined as the minimum instantaneous voltage including undershoot.

<sup>9</sup> Defined as the total variation of all crossing voltages of Rising REFCLK+ and Falling REFCLK-. This is the maximum allowed variance in V<sub>CROSS</sub> for any particular system.

<sup>10</sup> Refer to Section 4.3.7.1.1 of the PCI Express Base Specification, Revision 3.0 for information regarding PPM considerations.

<sup>11</sup> System board compliance measurements must use the test load. REFCLK+ and REFCLK- are to be measured at the load capacitors CL. Single ended probes must be used for measurements requiring single ended measurements. Either single ended probes with math or differential probe can be used for differential measurements. Test load CL = 2 pF.

<sup>12</sup> T<sub>STABLE</sub> is the time the differential clock must maintain a minimum ±150 mV differential voltage after rising/falling edges before it is allowed to droop back into the VRB ±100 mV differential range.

<sup>13</sup> PPM refers to parts per million and is a DC absolute period accuracy specification. 1 PPM is 1/1,000,000th of 100.000000 MHz exactly or 100 Hz. For 300 PPM, then we have an error budget of 100 Hz/PPM \* 300 PPM = 30 kHz. The period is to be measured with a frequency counter with measurement window set to 100 ms or greater. The  $\pm$ 300 PPM applies to systems that do not employ Spread Spectrum Clocking, or that use common clock source. For systems employing Spread Spectrum Clocking, there is an additional 2,500 PPM nominal shift in maximum period resulting from the 0.5% down spread resulting in a maximum average period specification of +2,800 PPM.

<sup>14</sup> Matching applies to rising edge rate for REFCLK+ and falling edge rate for REFCLK-. It is measured using a ±75 mV window centered on the median cross point where REFCLK+ rising meets REFCLK- falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations. The Rise Edge Rate of REFCLK+ should be compared to the Fall Edge Rate of REFCLK-; the maximum allowed difference should not exceed 20% of the slowest edge rate.

<sup>15</sup> At default SMBus amplitude settings.

# Electrical Characteristics–Filtered Phase Jitter Parameters - PCIe Common Clocked (CC) Architectures

T<sub>AMB</sub> = over the specified operating range. Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER    | SYMBOL                    | CONDITIONS  | MIN | TYP  | MAX  | INDUSTRY<br>LIMIT | UNITS       | Notes |
|--------------|---------------------------|---|-----|------|------|-------------------|-------------|-------|
|              | t <sub>jphPCleG1-CC</sub> | PCIe Gen 1  |     | 20   | 25   | 86                | рs<br>(р-р) | 1,2,3 |
| Phase Jitter | +                         | PCIe Gen 2 Lo Band<br>10kHz < f < 1.5MHz<br>(PLL BW of 5-16MHz or 8-5MHz, CDR = 5MHz)             |     | 0.5  | 0.6  | 3                 | ps<br>(rms) | 1,2   |
|              | <sup>I</sup> jphPCleG2-CC | PCIe Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)<br>(PLL BW of 5-16MHz or 8-5MHz, CDR = 5MHz) |     | 1.3  | 1.6  | 3.1               | ps<br>(rms) | 1,2   |
|              | t <sub>jphPCleG3-CC</sub> | PCIe Gen 3<br>(PLL BW of 2-4MHz or 2-5MHz, CDR = 10MHz)   |     | 0.36 | 0.50 | 1                 | ps<br>(rms) | 1,2   |
|              | t <sub>jphPCleG4-CC</sub> | PCIe Gen 4<br>(PLL BW of 2-4MHz or 2-5MHz, CDR = 10MHz)   |     | 0.36 | 0.50 | 0.5               | ps<br>(rms) | 1,2   |

<sup>1</sup> Applies to all outputs.

<sup>2</sup> Based on PCIe Base Specification Rev4.0 version 0.7draft. See http://www.pcisig.com for latest specifications.

<sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

# Electrical Characteristics–Filtered Phase Jitter Parameters - PCIe Separate Reference Independent Spread (SRIS) Architectures<sup>3</sup>

T<sub>AMB</sub> = over the specified operating range. Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL                           | CONDITIONS  | MIN | TYP | MAX  | INDUSTRY<br>LIMIT | UNITS       | Notes |
|------------------------|----------------------------------|---|-----|-----|------|-------------------|-------------|-------|
| Dhara litter DLL Mada  | t <sub>jphPCIeG2</sub> -<br>SRIS | PCIe Gen 2<br>(PLL BW of 16MHz , CDR = 5MHz)            |     | 0.7 | 1.1  | 2                 | ps<br>(rms) | 1,2   |
| Phase Jitter, PLL Mode | t <sub>jphPCleG3</sub> .<br>SRIS | PCIe Gen 3<br>(PLL BW of 2-4MHz or 2-5MHz, CDR = 10MHz) |     | 0.5 | 0.65 | 0.7               | ps<br>(rms) | 1,2   |

<sup>1</sup> Applies to all outputs.

<sup>2</sup> Based on PCIe Base Specification Rev3.1a. These filters are different than Common Clock filters. See http://www.pcisig.com for latest specifications. There is a proposal to reduce the PCIe Gen3 limit to 0.5ps.

<sup>3</sup> As of PCIe Base Specification Rev4.0 draft 0.7, SRIS is not currently defined for Gen1 or Gen4.

## **Electrical Characteristics–DIF LP-HCSL Output Unfiltered Phase Jitter Parameters**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER             | SYMBOL                 | CONDITIONS  | MIN | TYP | MAX | INDUSTRY<br>LIMIT | UNITS       |
|-----------------------|------------------------|---|-----|-----|-----|-------------------|-------------|
| Phase Jitter, 12k-20M | t <sub>jph12k20M</sub> | 100MHz outputs with REF output enabled<br>SSC Off |     | 1.5 | 2   | N/A               | ps<br>(rms) |

## **Electrical Characteristics–Current Consumption**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| AND, Copper, Consigned                        |                    | peraner: eenaner; eee reer _eaae rei _eaam.g e   |     |     |     |       |       |
|---|--------------------|--|-----|-----|-----|-------|-------|
| PARAMETER                                     | SYMBOL             | CONDITIONS   | MIN | TYP | MAX | UNITS | NOTES |
|   | IDDAOP             | VDDA, All outputs active @100MHz   |     | 13  | 16  | mA    |       |
| Operating Supply Current                      | I <sub>DDOP</sub>  | All other VDD, except VDDA, All outputs active     29     40       OP     @100MHz     29     40       APD     VDDA, DIF outputs off, REF output running     0.7     1.5       All other VDD, except VDDA,     0.0     11 | mA  |     |     |       |       |
| Wake-on-LAN Current                           | IDDAPD             | VDDA, DIF outputs off, REF output running  |     | 0.7 | 1.5 | mA    | 1     |
| (Power down state and<br>Byte 3, bit 5 = '1') | I <sub>DDPD</sub>  | , , ,  |     | 8.8 | 14  | mA    | 1     |
| Powerdown Current<br>(Power down state and    | I <sub>DDAPD</sub> | VDDA, all outputs off  |     | 0.7 | 1.5 | mA    |       |
| Byte 3, bit 5 = '0')                          | I <sub>DDPD</sub>  | All other VDD, except VDDA, all outputs off  |     | 4.7 | 8   | mA    |       |

<sup>1</sup> This is the current required to have the REF output running in Wake-on-LAN mode (Byte 3, bit 5 = 1)

# **Electrical Characteristics- REF**

 $TA = T_{AMB}$ ; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL                | CONDITIONS  | MIN TYP MAX                        |      | UNITS             | Notes   |     |
|------------------------|-----------------------|---|------------------------------------|------|-------------------|---|-----|
| Long Accuracy          | ppm                   | see Tperiod min-max values  |                                    | 0    |                   | ppm   | 1,2 |
| Clock period           | Tperiod               | REF output  |                                    | 40   |                   | ns  | 2   |
| High output Voltage    | V <sub>HIGH</sub>     | I <sub>OH</sub> = -2mA  | $0.8 \mathrm{xV}_{\mathrm{DDREF}}$ |      |                   | v   |     |
| Low output Voltage     | V <sub>LOW</sub>      | $I_{OL} = 2mA$  |                                    |      | $0.2 x V_{DDREF}$ | V   |     |
|                        | t <sub>rf1</sub>      | Byte 3 = 1F, V <sub>OH</sub> = 0.8*VDD, V <sub>OL</sub> = 0.2*VDD | 0.5                                | 0.9  | 1.2               | V/ns  | 1   |
| Rise/Fall Slew Rate    | t <sub>rf1</sub>      | Byte 3 = 5F, VOH = 0.8*VDD, VOL = 0.2*VDD                         | 1.0                                | 1.5  | 2.0               | V/ns  | 1,3 |
| nise/ Fail Siew hale   | t <sub>rf1</sub>      | Byte 3 = 9F, VOH = 0.8*VDD, VOL = 0.2*VDD                         | 1.5                                | 2.2  | 2.6               | V/ns  | 1   |
|                        | t <sub>rf1</sub>      | Byte 3 = DF, VOH = 0.8*VDD, VOL = 0.2*VDD                         | 2.0                                | 2.9  | 3.2               | V/ns  | 1   |
| Duty Cycle             | d <sub>t1X</sub>      | $V_T = VDD/2 V$   | 45                                 | 50.2 | 55                | %   | 1,4 |
| Duty Cycle Distortion  | $d_{tcd}$             | $V_T = VDD/2 V$   | -1                                 | -0.5 | 0                 | %   | 1,5 |
| Jitter, cycle to cycle | t <sub>jcyc-cyc</sub> | $V_T = VDD/2 V$   |                                    | 70   | 150               | ps  | 1,4 |
| Noise floor            | t <sub>jdBc1k</sub>   | 1kHz offset   |                                    | -145 | -135              | ppm<br>ns<br>V<br>V/ns<br>V/ns<br>V/ns<br>V/ns<br>V/ns<br>% | 1,4 |
|                        | t <sub>jdBc10k</sub>  | 10kHz offset to Nyquist   |                                    | -150 | -140              |   | 1,4 |
| Jitter, phase          | t <sub>jphREF</sub>   | 12kHz to 5MHz, DIF SSC Off  |                                    | 0.13 | 0.3               | ps (rms)  | 1,4 |
|                        | t <sub>jphREF</sub>   | 12kHz to 5MHz, DIF SSC On   |                                    | 1.5  | 2                 | ps (rms)  | 1,4 |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is trimmed to 25.00 MHz

<sup>3</sup> Default SMBus Value

<sup>4</sup> When driven by a crystal.

<sup>5</sup> When driven by an external oscillator via the X1 pin, X2 should be floating.

# **General SMBus Serial Interface Information**

## How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will **acknowledge**
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

|           | Index Bl   | ock W  | rite Operation       |
|-----------|------------|--------|----------------------|
| Controll  | er (Host)  |        | IDT (Slave/Receiver) |
| Т         | starT bit  |        |                      |
| Slave A   | Address    |        |                      |
| WR        | WRite      |        |                      |
|           |            |        | ACK                  |
| Beginning | g Byte = N |        |                      |
|           |            |        | ACK                  |
| Data Byte | Count = X  |        |                      |
|           |            |        | ACK                  |
| Beginnin  | ng Byte N  |        |                      |
|           |            |        | ACK                  |
| 0         |            | ×      |                      |
| 0         |            | X Byte | 0                    |
| 0         |            | Ø      | 0                    |
|           |            |        | 0                    |
| Byte N    | + X - 1    |        |                      |
|           |            |        | ACK                  |
| Р         | stoP bit   |        |                      |

Note: SMBus Read/Write Address is Latched on SADR pin. Unless otherwise indicated, default values are for the xx41 and xx51. P1 devices are fully factory programmable.

## How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

|      | Index Block F   | lead O | peration             |
|------|-----------------|--------|----------------------|
| Cor  | ntroller (Host) |        | IDT (Slave/Receiver) |
| Т    | starT bit       |        |                      |
| SI   | ave Address     |        |                      |
| WR   | WRite           |        |                      |
|      |                 | -      | ACK                  |
| Begi | nning Byte = N  | -      |                      |
|      |                 | -      | ACK                  |
| RT   | Repeat starT    | -      |                      |
| SI   | ave Address     |        |                      |
| RD   | ReaD            |        |                      |
|      |                 |        | ACK                  |
|      |                 |        |                      |
|      |                 | -      | Data Byte Count=X    |
|      | ACK             |        |                      |
|      |                 | -      | Beginning Byte N     |
|      | ACK             | -      |                      |
|      |                 | ę      | 0                    |
|      | 0               | X Byte | 0                    |
|      | 0               | ×      | 0                    |
|      | 0               |        |                      |
|      |                 |        | Byte N + X - 1       |
| N    | Not acknowledge |        |                      |
| Р    | stoP bit        |        |                      |

## SMBus Table: Output Enable Register

| Byte 0 | Name     | <b>Control Function</b> | Туре | 0       | 1           | Default |  |
|--------|----------|-------------------------|------|---------|-------------|---------|--|
| Bit 7  |          | Reserve                 | d    |         | -           | Х       |  |
| Bit 6  |          | Reserved                |      |         |             |         |  |
| Bit 5  | Reserved |                         |      |         |             |         |  |
| Bit 4  | Reserved |                         |      |         |             |         |  |
| Bit 3  | DIF OE3  | Output Enable           | RW   | Low/Low | Pin Control | 1       |  |
| Bit 2  | DIF OE2  | Output Enable           | RW   | Low/Low | Pin Control | 1       |  |
| Bit 1  | DIF OE1  | Output Enable           | RW   | Low/Low | Pin Control | 1       |  |
| Bit 0  | DIF OE0  | Output Enable           | RW   | Low/Low | Pin Control | 1       |  |

1. A low on these bits will overide the OE# pin and force the differential output to the state indicated by B11[1:0] (Low/Low default).

#### SMBus Table: SS Readback and Vhigh Control Register

| Byte 1 | Name         | Control Function            | Туре            | 0   | 1                                       | Default |
|--------|--------------|-----------------------------|-----------------|---|---|---------|
| Bit 7  | SSENRB1      | SS Enable Readback Bit1     | R               | 00' for SS_EN_tri = 0, '01' for SS_EN_tri |   | Latch   |
| Bit 6  | SSENRB1      | SS Enable Readback Bit0     | R               | = 'M', '11 for S                          | S_EN_tri = '1'                          | Latch   |
| Bit 5  | SSEN_SWCNTRL | Enable SW control of SS     | RW              | SS control locked                         | Values in B1[4:3]<br>control SS amount. | 0       |
| Bit 4  | SSENSW1      | SS Enable Software Ctl Bit1 | RW <sup>1</sup> | 00' = SS Off, '0'                         | 1' = -0.25% SS,                         | 0       |
| Bit 3  | SSENSW0      | SS Enable Software Ctl Bit0 | RW <sup>1</sup> | '10' = Reserved,                          | , '11'= -0.5% SS                        | 0       |
| Bit 2  |              | Reserved                    |                 |   |   | Х       |
| Bit 1  | AMPLITUDE 1  | Controls Output Amplitude   | RW              | 00 = 0.6V                                 | 01= 0.68V                               | 1       |
| Bit 0  | AMPLITUDE 0  |                             | RW              | 10 = 0.75V                                | 11 = 0.85V                              | 0       |

1. B1[5] must be set to a 1 for these bits to have any effect on the part. These values are for xx41, and xx51. P1 is factory programmal

#### SMBus Table: DIF Slew Rate Control Register

| Byte 2 | Name             | Control Function         | Туре | 0            | 1            | Default |
|--------|------------------|--------------------------|------|--------------|--------------|---------|
| Bit 7  |                  | Reserved                 |      |              |              | Х       |
| Bit 6  |                  | Reserved                 |      |              |              | Х       |
| Bit 5  |                  | Reserved                 |      |              |              | Х       |
| Bit 4  |                  | Reserved                 |      |              |              | Х       |
| Bit 3  | SLEWRATESEL DIF3 | Adjust Slew Rate of DIF3 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 2  | SLEWRATESEL DIF2 | Adjust Slew Rate of DIF2 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 1  | SLEWRATESEL DIF1 | Adjust Slew Rate of DIF1 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 0  | SLEWRATESEL DIF0 | Adjust Slew Rate of DIF0 | RW   | Slow Setting | Fast Setting | 1       |

Note: See "Low-Power HCSL Outputs" table for slew rates.

#### SMBus Table: REF Control Register

| Byte 3 | Name   | Control Function            | Туре | 0               | 1                 | Default |
|--------|--|-----------------------------|------|-----------------|-------------------|---------|
| Bit 7  | REF  | Slew Rate Control           | RW   | 00 = Slowest    | 01 =Slow          | 0       |
| Bit 6  |  |                             | RW   | 10 = Fast       | 11 = Fastest      | 1       |
| Bit 5  | t 5 REF Power Down Function Wake-on-Lan Enable for REF | Wake on I an Enable for REE | RW   | REF disabled in | REF runs in Power | 0       |
| DIUS   |  |                             | 1.00 | Power Down      | Down              | U U     |
| Bit 4  | REF OE   | REF Output Enable           | RW   | Disabled        | Enabled           | 1       |
| Bit 3  |  | Reserved                    |      |                 |                   | Х       |
| Bit 2  |  | Reserved                    |      |                 |                   | Х       |
| Bit 1  | Reserved   |                             |      |                 |                   | X       |
| Bit 0  |  | Reserved                    |      |                 |                   | Х       |

Byte 4 is Reserved



#### SMBus Table: Revision and Vendor ID Register

| Byte 5 | Name | Control Function | Туре | 0            | 1 | Default |
|--------|------|------------------|------|--------------|---|---------|
| Bit 7  | RID3 |                  | R    | B rev = 0001 |   | 0       |
| Bit 6  | RID2 | Revision ID      | R    |              |   | 0       |
| Bit 5  | RID1 | REVISIONID       | R    |              |   | 0       |
| Bit 4  | RID0 |                  | R    |              | 1 |         |
| Bit 3  | VID3 |                  | R    |              |   | 0       |
| Bit 2  | VID2 | VENDOR ID        | R    | 0001         |   | 0       |
| Bit 1  | VID1 | VENDORID         | R    | - 0001 = IDT |   | 0       |
| Bit 0  | VID0 | 7                | R    |              |   | 1       |

#### SMBus Table: Device Type/Device ID

| Byte 6 | Name         | Control Function | Туре                  | 0                        | 1            | Default |
|--------|--------------|------------------|-----------------------|--------------------------|--------------|---------|
| Bit 7  | Device Type1 | Device Type      | R 00 = FGx, 01 = DBx, |                          | 0            |         |
| Bit 6  | Device Type0 | Device Type      | R                     | 10 = DMx, 11= DBx w/oPLL |              | 0       |
| Bit 5  | Device ID5   |                  | R                     |                          |              | 0       |
| Bit 4  | Device ID4   |                  | R                     |                          |              |         |
| Bit 3  | Device ID3   | Device ID        | R                     | 000100 bina              | ny or 04 bey | 0       |
| Bit 2  | Device ID2   | Device ID        | R                     | 000100 0114              |              | 1       |
| Bit 1  | Device ID1   | ]                | R                     |                          |              | 0       |
| Bit 0  | Device ID0   |                  | R                     |                          |              | 0       |

## SMBus Table: Byte Count Register

| Byte 7 | Name     | Control Function       | Туре | 0                      | 1                     | Default |
|--------|----------|------------------------|------|------------------------|-----------------------|---------|
| Bit 7  | Reserved |                        |      |                        |                       |         |
| Bit 6  | Reserved |                        |      |                        |                       |         |
| Bit 5  |          | Reserved               |      |                        |                       | Х       |
| Bit 4  | BC4      |                        | RW   |                        |                       | 0       |
| Bit 3  | BC3      |                        | RW   | Writing to this regist | er will configure how | 1       |
| Bit 2  | BC2      | Byte Count Programming | RW   | many bytes will be r   | ead back, default is  | 0       |
| Bit 1  | BC1      |                        | RW   | = 8 b                  | ytes.                 | 0       |
| Bit 0  | BC0      |                        | RW   |                        |                       | 0       |

Bytes 8 and 9 are Reserved

## SMBus Table: PD\_Restore

| Byte 10 | Name                    | Control Function              | Туре | 0                  | 1                 | Default |
|---------|-------------------------|-------------------------------|------|--------------------|-------------------|---------|
| Bit 7   | Reserved                | Reserve bit, leave at default | RW   | Reserved           | Reserved          | 0       |
| Bit 6   | Power-Down (PD) Restore | Restore Default Config. In PD | RW   | Clear Config in PD | Keep Config in PD | 1       |
| Bit 5   |                         | Reserved                      |      |                    |                   | Х       |
| Bit 4   | Reserved                |                               |      |                    |                   | Х       |
| Bit 3   |                         | Reserved                      |      |                    |                   | Х       |
| Bit 2   | Reserved                |                               |      |                    |                   | Х       |
| Bit 1   | Reserved                |                               |      |                    |                   | Х       |
| Bit 0   |                         | Reserved                      |      |                    |                   | X       |

## SMBus Table: Stop State Control

| Byte 11 | Name  | Control Function | Туре | 0            | 1             | Default |
|---------|---|------------------|------|--------------|---------------|---------|
| Bit 7   |   | Reserved         |      |              |               | Х       |
| Bit 6   |   | Reserved         |      |              |               |         |
| Bit 5   |   | Reserved         |      |              |               | Х       |
| Bit 4   |   | Reserved         |      |              |               | Х       |
| Bit 3   |   | Reserved         |      |              |               | Х       |
| Bit 2   |   | Reserved         |      |              |               | Х       |
| Bit 1   | STP[1] True/Complement DIF Output RW 00 = Low/Low 10 = High/Low |                  |      |              |               |         |
| Bit 0   | STP[0]  | Disable State    | RW   | 01 = HiZ/HiZ | 11 = Low/High | 0       |

## SMBus Table: Impedance Control

| Byte 12 | Name        | Control Function | Туре | 0               | 1                | Default  |
|---------|-------------|------------------|------|-----------------|------------------|----------|
| Bit 7   | DIF1_imp[1] | DIF1 Zout        | RW   | 00=33+ DIF Zout | 10=100+ DIF Zout | See Note |
| Bit 6   | DIF1_imp[0] | DIF1 Zout        | RW   | 01=85+ DIF Zout | 11 = Reserved    | See Note |
| Bit 5   | Reserved    |                  |      |                 | Х                |          |
| Bit 4   | Reserved    |                  |      |                 |                  | Х        |
| Bit 3   | DIF0_imp[1] | DIF0 Zout        | RW   | 00=33+ DIF Zout | 10=100+ DIF Zout | See Note |
| Bit 2   | DIF0_imp[0] | DIF0 Zout        | RW   | 01=85+ DIF Zout | 11 = Reserved    | See Note |
| Bit 1   | Reserved    |                  |      |                 | Х                |          |
| Bit 0   | Reserved    |                  |      |                 | Х                |          |

## SMBus Table: Impedance Control

| Byte 13 | Name        | Control Function | Туре | 0               | 1                | Default  |
|---------|-------------|------------------|------|-----------------|------------------|----------|
| Bit 7   | Reserved    |                  |      |                 |                  | Х        |
| Bit 6   |             | Reserved         |      |                 |                  | Х        |
| Bit 5   | DIF3_imp[1] | DIF3 Zout        | RW   | 00=33+ DIF Zout | 10=100+ DIF Zout | See Note |
| Bit 4   | DIF3_imp[0] | DIF3 Zout        | RW   | 01=85+ DIF Zout | 11 = Reserved    | See Note |
| Bit 3   | DIF2_imp[1] | DIF2 Zout        | RW   | 00=33+ DIF Zout | 10=100+ DIF Zout | See Note |
| Bit 2   | DIF2_imp[0] | DIF2 Zout        | RW   | 01=85+ DIF Zout | 11 = Reserved    | See Note |
| Bit 1   | Reserved    |                  |      |                 | Х                |          |
| Bit 0   |             | Reserved         |      |                 |                  | Х        |

## SMBus Table: Pull-up Pull-down Control

| Byte 14 | Name         | Control Function               | Туре | 0       | 1             | Default |
|---------|--------------|--------------------------------|------|---------|---------------|---------|
| Bit 7   | OE1_pu/pd[1] | OE1_pu/pd[1] OE1 Pull-up(PuP)/ |      |         | 10=Pup        | 0       |
| Bit 6   | OE1_pu/pd[0] | Pull-down(Pdwn) control        | RW   | 01=Pdwn | 11 = Pup+Pdwn | 1       |
| Bit 5   | Reserved     |                                |      |         |               | Х       |
| Bit 4   | Reserved     |                                |      |         |               | Х       |
| Bit 3   | OE0pu/pd[1]  | OE0Pull-up(PuP)/               | RW   | 00=None | 10=Pup        | 0       |
| Bit 2   | OE0_pu/pd[0] | Pull-down(Pdwn) control        | RW   | 01=Pdwn | 11 = Pup+Pdwn | 1       |
| Bit 1   | Reserved     |                                |      |         |               | Х       |
| Bit 0   |              | Reserved                       |      |         |               | Х       |

## SMBus Table: Pull-up Pull-down Control

| Byte 15 | Name         | Control Function        | Туре | 0       | 1             | Default |
|---------|--------------|-------------------------|------|---------|---------------|---------|
| Bit 7   |              | Reserved                |      |         |               | Х       |
| Bit 6   |              | Reserved                |      |         |               | Х       |
| Bit 5   | OE3_pu/pd[1] | OE3 Pull-up(PuP)/       | RW   | 00=None | 10=Pup        | 0       |
| Bit 4   | OE3_pu/pd[0] | Pull-down(Pdwn) control | RW   | 01=Pdwn | 11 = Pup+Pdwn | 1       |
| Bit 3   | OE2_pu/pd[1] | OE2 Pull-up(PuP)/       | RW   | 00=None | 10=Pup        | 0       |
| Bit 2   | OE2_pu/pd[0] | Pull-down(Pdwn) control | RW   | 01=Pdwn | 11 = Pup+Pdwn | 1       |
| Bit 1   | Reserved     |                         |      |         |               | Х       |
| Bit 0   |              | Reserved                |      |         |               | Х       |

## SMBus Table: Pull-up Pull-down Control

| Byte 16 | Name   | Control Function | Туре | 0 | 1 | Default |  |
|---------|--|------------------|------|---|---|---------|--|
| Bit 7   |  | Reserved         |      |   |   |         |  |
| Bit 6   |  | Reserved         |      |   |   | 0       |  |
| Bit 5   |  | Reserved         |      |   |   | 1       |  |
| Bit 4   |  | Reserved         |      |   |   | 0       |  |
| Bit 3   |  | Reserved         |      |   |   | 0       |  |
| Bit 2   |  | Reserved         |      |   |   | 1       |  |
| Bit 1   | CKPWRGD_PD_pu/pd[1] CKPWRGD_PD Pull-up(PuP)/ RW 00=None 10=Pup |                  |      |   |   | 1       |  |
| Bit 0   | CKPWRGD_PD_pu/pd[0]  |                  |      |   |   | 0       |  |

Byte 17 is Reserved

## SMBus Table: Polarity Control

| Byte 18 | Name   | Control Function   | Туре | 0                | 1                 | Default |  |  |
|---------|--|--|------|------------------|-------------------|---------|--|--|
| Bit 7   |  | Reserved   |      |                  |                   |         |  |  |
| Bit 6   | OE3_polarity   | OE3_polarity Sets OE3 polarity RW Enabled when Low Enabled when High |      |                  |                   |         |  |  |
| Bit 5   | OE2_polarity   | OE2_polarity Sets OE2 polarity RW Enabled when Low Enabled when High |      |                  |                   |         |  |  |
| Bit 4   |  | Reserved   |      |                  |                   | 0       |  |  |
| Bit 3   | OE1_polarity   | Sets OE1 polarity  | RW   | Enabled when Low | Enabled when High | 0       |  |  |
| Bit 2   |  | Reserved   |      |                  |                   | 0       |  |  |
| Bit 1   | OE0_polarity Sets OE0 polarity RW Enabled when Low Enabled when High |  |      |                  |                   |         |  |  |
| Bit 0   |  | Reserved   |      |                  |                   | 0       |  |  |

## SMBus Table: Polarity Control

| Byte 19 | Name       | Control Function                           | Туре | 0 | 1 | Default |  |
|---------|------------|--|------|---|---|---------|--|
| Bit 7   |            | Reserved                                   |      |   |   |         |  |
| Bit 6   |            | Reserved                                   |      |   |   |         |  |
| Bit 5   |            | Reserved                                   |      |   |   | 0       |  |
| Bit 4   | Reserved   |  |      |   | 0 |         |  |
| Bit 3   |            | Reserved                                   |      |   |   | 0       |  |
| Bit 2   |            | Reserved                                   |      |   |   | 0       |  |
| Bit 1   |            | Reserved                                   |      |   |   | 0       |  |
| Bit 0   | CKPWRGD_PD | Determines Power Down when Power Down when |      |   |   |         |  |

# **Recommended Crystal Characteristics (3225 package)**

| PARAMETER                            | VALUE       | UNITS         | NOTES |
|--------------------------------------|-------------|---------------|-------|
| Frequency                            | 25          | MHz           | 1     |
| Resonance Mode                       | Fundamental | -             | 1     |
| Frequency Tolerance @ 25°C           | ±20         | PPM Max       | 1     |
| Frequency Stability, ref @ 25°C Over | +20         | PPM Max       | 1     |
| Operating Temperature Range          | 120         | F F IVI IVIAX | 1     |
| Temperature Range (commerical)       | 0~70        | °C            | 1     |
| Temperature Range (industrial)       | -40~85      | °C            | 1     |
| Equivalent Series Resistance (ESR)   | 50          | Ω Max         | 1     |
| Shunt Capacitance (C <sub>O</sub> )  | 7           | pF Max        | 1     |
| Load Capacitance (C <sub>L</sub> )   | 8           | pF Max        | 1     |
| Drive Level                          | 0.3         | mW Max        | 1     |
| Aging per year                       | ±5          | PPM Max       | 1     |

#### Notes:

1. FOX 603-25-150

## **Marking Diagrams**



## Notes:

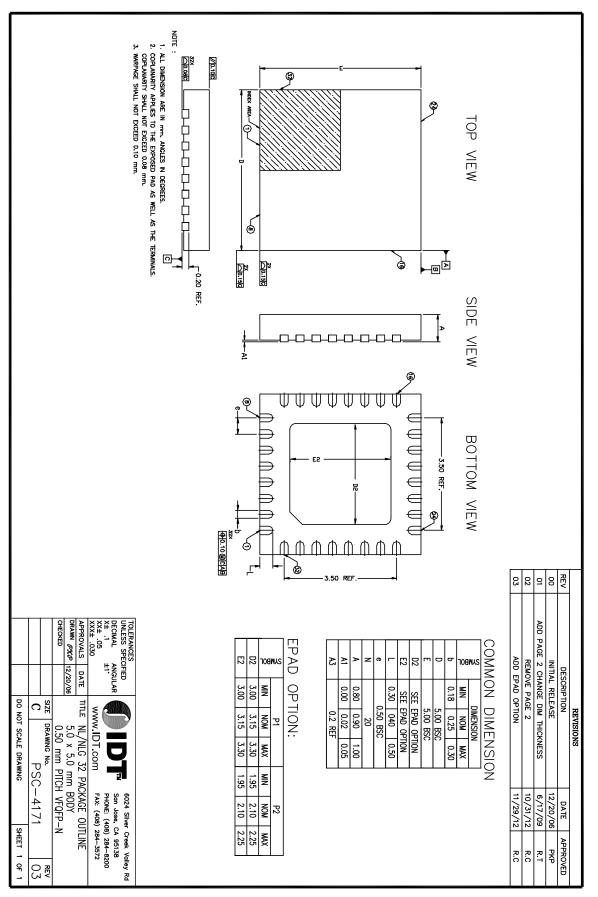
- 1. "LOT" is the lot sequence number.
- 2. "COO" denotes country of origin.
- 3. "YYWW" is the last two digits of the year and week that the part was assembled.
- 4. Line 2: truncated part number.
- 5. "L" denotes RoHS compliant package.
- 6. "I" denotes industrial temperature range device.
- 7. "P" denotes factory programmable defaults.

## **Thermal Characteristics**

| PARAMETER          | SYMBOL           | CONDITIONS                      | PKG     | TYP. | UNITS | NOTES |
|--------------------|------------------|---------------------------------|---------|------|-------|-------|
|                    | θ <sub>JC</sub>  | Junction to Case                |         | 42   | ∘C/W  | 1     |
|                    | $\theta_{Jb}$    | Junction to Base                |         | 2.4  | °C/W  | 1     |
| Thermal Resistance | θ <sub>JA0</sub> | Junction to Air, still air      | NLG32   | 39   | °C/W  | 1     |
| memai nesistance   | θ <sub>JA1</sub> | Junction to Air, 1 m/s air flow | INLCI32 | 33   | °C/W  | 1     |
|                    | $\theta_{JA3}$   | Junction to Air, 3 m/s air flow |         | 28   | ∘C/W  | 1     |
|                    | $\theta_{JA5}$   | Junction to Air, 5 m/s air flow |         | 27   | °C/W  | 1     |

<sup>1</sup>ePad soldered to board

# Package Outline and Package Dimensions (NLG32) – use EPAD Option P1



## **Ordering Information**

| Part / Order Number | Notes                                    | Shipping Packaging | Package       | Temperature   |
|---------------------|--|--------------------|---------------|---------------|
| 9FGL0441BKILF       | 100Ω                                     | Trays              | 32-pin VFQFPN | -40 to +85° C |
| 9FGL0441BKILFT      | 10022                                    | Tape and Reel      | 32-pin VFQFPN | -40 to +85° C |
| 9FGL0451BKILF       | 85Ω                                      | Trays              | 32-pin VFQFPN | -40 to +85° C |
| 9FGL0451BKILFT      | 0022                                     | Tape and Reel      | 32-pin VFQFPN | -40 to +85° C |
| 9FGL04P1BxxxKILF    | Factory configurable.<br>Contact IDT for | Trays              | 32-pin VFQFPN | -40 to +85° C |
| 9FGL04P1BxxxKILFT   |  | Tape and Reel      | 32-pin VFQFPN | -40 to +85° C |

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

"B" is the device revision designator (will not correlate with the datasheet revision).

"xxx" is a unique factory assigned number to identify a particular default configuration.

# **Revision History**

| Rev. | Issue Date | Intiator | Description  | Page #  |
|------|------------|----------|--|---------|
| A    | 7/16/2015  | RDW      | <ol> <li>Update electrical tables with characterization data.</li> <li>Minor formatting updates for readability and consistency.</li> <li>Added I-temp crystal part number to crystal characteristics table</li> <li>Added reference to AN-891 for terminating to other logic families.</li> <li>Removed LVDS termination drawing (now in AN-891)</li> </ol>   | Various |
| В    | 8/6/2015   | RDW      | 1. Clarified Conditions statement for IDDOP parameters in the Current Consumption table.   | 8       |
| с    | 2/4/2016   | RDW      | <ol> <li>Updated ordering information to B rev</li> <li>Updated byte 5 values</li> <li>Updated block diagram</li> </ol>  | Various |
| D    | 4/20/2016  | RDW      | <ol> <li>Removed VDDIO reference, this part does not have the feature</li> <li>Clarified that the 9FGL04P device has 8MHz to 40MHz input</li> <li>Glarified that the 9FGL04P device has 8MHz to 40MHz input</li> <li>Updated max IDD for case WOL mode from 11mA to 14mA.</li> <li>Corrected Stop State Control bit decode in Byte 11</li> <li>Updated Amplitude Control Bit Decode in Byte 1</li> </ol> |         |
| E    | 6/3/12016  | RDW      | <ol> <li>Update electrical tables for B rev production release</li> <li>Added PCIe SRIS and PCIe Gen4 CC to phase jitter tables.</li> <li>Updated front page text.</li> <li>Removed '000' blank device from ordering information.</li> <li>Updated Byte0 wording for clarity</li> <li>Updated Byte1[1:0] descriptions.</li> </ol>  | Various |
| F    | 6/22/12016 | RDW      | 1. Updated electrical tables with final data from PE/TE  | Various |
| G    | 10/18/2016 | RDW      | Removed IDT crystal part number  |         |



#### Corporate Headquarters 6024 Silver Creek Valley Road San Jose, CA 95138 USA www.IDT.com

Sales 1-800-345-7015 or 408-284-8200 Fax: 408-284-2775 www.IDT.com/go/sales

#### Tech Support www.idt.com/go/support

DISCLAIMER Integrated Device Technology, Inc. (IDT) and its subsidiaries reserve the right to modify the products and/or specifications described herein at any time and at IDT's sole discretion. All information in this document, including descriptions of product features and performance, is subject to change without notice. Performance specifications and the operating parameters of the described products are determined in the independent state and are not guaranteed to perform the same way when installed in customer products. The information contained herein is provided without representation or warranty of any kind, whether express or implied, including, but not limited to, the suitability of IDT's products for any particular purpose, an implied warranty of merchantability, or non-infringement of the intellectual property rights of others. This document is presented only as a guide and does not convey any license under intellectual property rights of IDT or any third parties.

IDT's products are not intended for use in applications involving extreme environmental conditions or in life support systems or similar devices where the failure or malfunction of an IDT product can be reasonably expected to significantly affect the health or safety of users. Anyone using an IDT product in such a manner does so at their own risk, absent an express, written agreement by IDT.

Integrated Device Technology, IDT and the IDT logo are registered trademarks of IDT. Product specification subject to change without notice. Other trademarks and service marks used herein, including protected names, logos and designs, are the property of IDT or their respective third party owners.

Copyright ©2016 Integrated Device Technology, Inc.. All rights reserved.